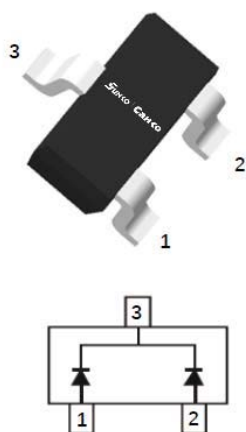


DAN222

Dual Switching Diode



Features

- Moisture sensitivity level 1
- Reverse voltage: 80V
- Average forward current: 100mA

Application

- High frequency rectifier
- Signal switching

Mechanical data

- **Package:** SOT-523
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102

■ Maximum Ratings (T_a=25°C Unless otherwise specified)

Parameter	Symbol	Unit	Value
Device marking code			N
Repetitive peak reverse voltage	V _{RRM}	V	80
Forward current, per leg	I _F	mA	100
Non-repetitive surge peak forward current @ t=8.3ms half-sine wave	I _{FSM}	A	1
Non-repetitive surge peak forward current @ t=1ms square wave			1.5
Non-repetitive surge peak forward current @ t=1us square wave			2
Power dissipation	P _D	mW	150
Junction temperature	T _J	°C	-55 to +150
Storage temperature	T _{STG}	°C	-55 to +150

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■ Electrical Characteristics (T_a=25°C Unless otherwise specified)

Parameter	Symbol	Unit	Conditions	Min	Typ	Max
Reverse voltage	V _R	V	I _R =100uA	80		
Forward voltage	V _F	V	I _F =100mA			1.2
Reverse leakage current	I _R	nA	V _R =70V			100
Junction capacitance	C _j	pF	f=1.0MHz, V _R =6V			3.5
Reverse recovery time	T _{rr}	ns	I _F =I _R =10mA I _{rr} =0.1*I _R , R _L =100Ω			4

■ Thermal Characteristics

Parameter	Symbol	Unit	Value
Thermal resistance, junction-to-ambient	R _{θJ-A} ⁽¹⁾	°C/W	833
Thermal resistance, junction-to-case	R _{θJ-C} ⁽¹⁾	°C/W	666

Note:

(1) Thermal resistance from junction to ambient and from junction to case mounted on P.C.B. with 25.4mm*25.4mm copper pad areas

■ **Characteristics**

Fig 1: P_D - T_a Curve

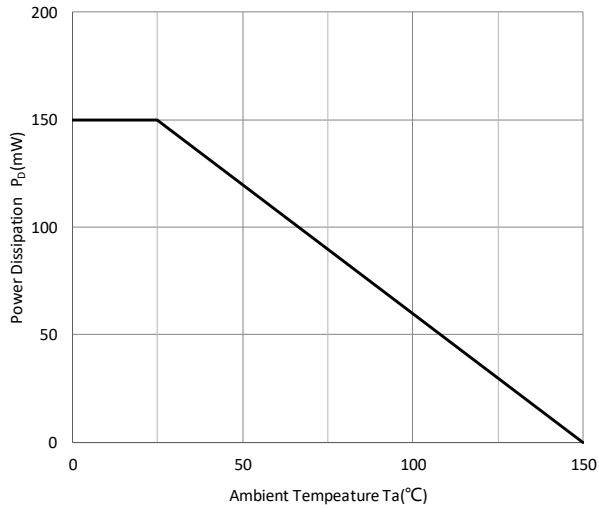


Fig 2: Capacitance Capability

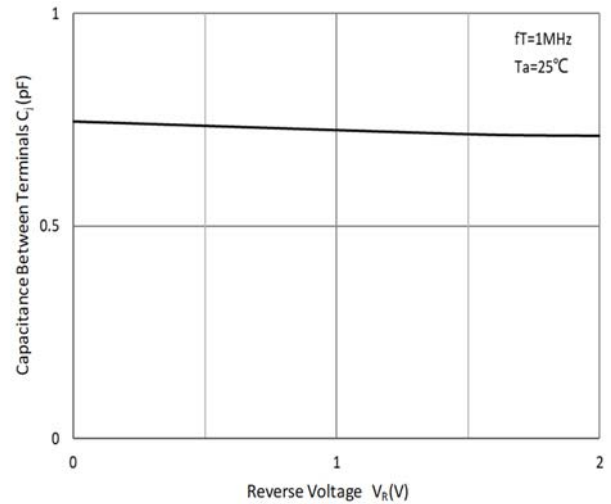


Fig 3: Typical Forward Characteristics

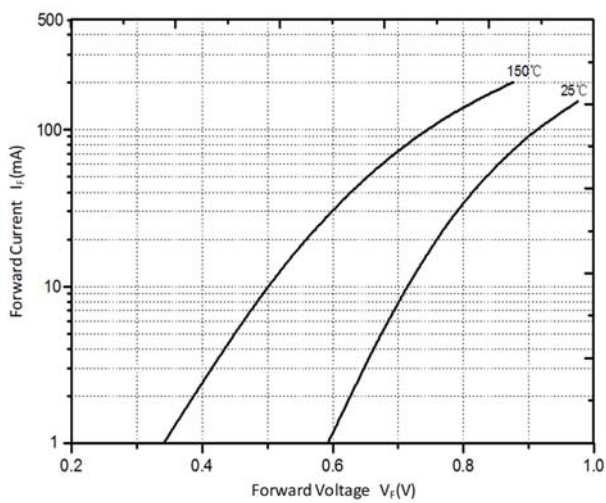
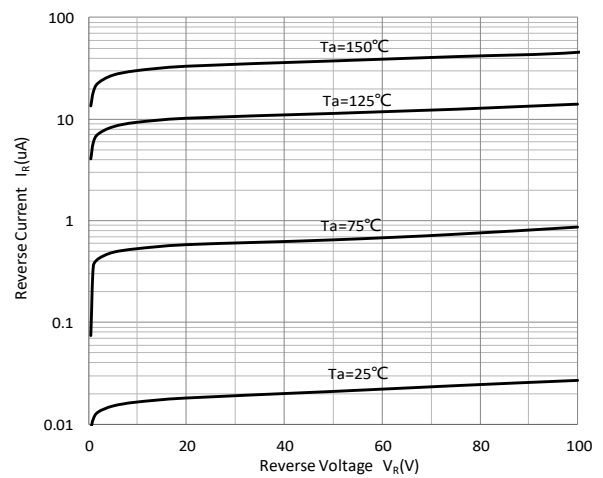


Fig 4: Typical Reverse Characteristics

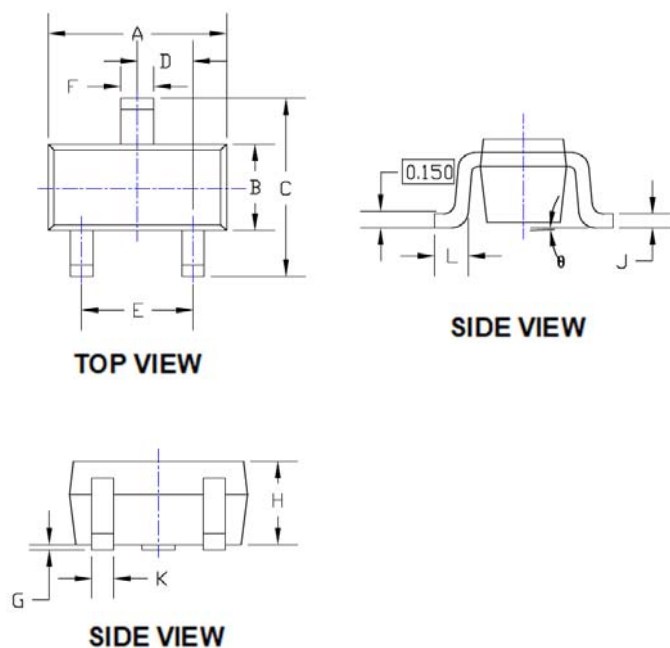


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■ Ordering Information

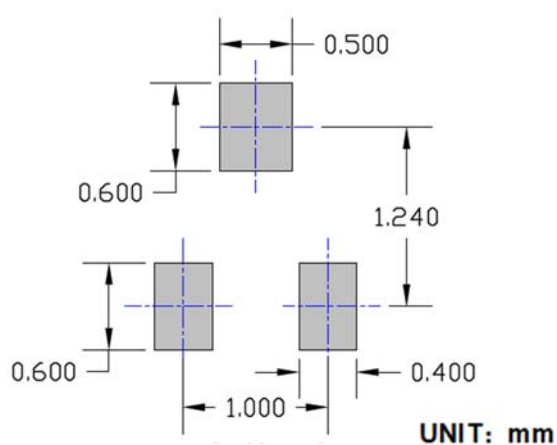
Preferred P/N	Packing code	Unit weight(g)	Minimum package(pcs)	Inner box quantity(pcs)	Outer carton quantity(pcs)	Delivery mode
DAN222	F2	Approximate 0.0027	3000	30000	120000	7" reel

■ Outline Dimensions



SYMBOL	DIMENSIONS			
	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.059	0.067	1.500	1.700
B	0.030	0.033	0.750	0.850
C	0.057	0.069	1.450	1.750
D	0.020TYP		0.500TYP	
E	0.035	0.043	0.900	1.100
F	0.010	0.018	0.250	0.450
G	0.000	0.004	0.000	0.100
H	0.024	0.031	0.600	0.800
J	0.004	0.008	0.100	0.200
K	0.006	0.014	0.150	0.350
L	0.010	0.018	0.260	0.460
θ	0°	8°	0°	8°

■ Suggested Pad Layout



DAN222

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